

Improvements TEA2017AAT/3 vs. the TEA2017AAT/2

TEA2017AAT/2

Reference start-up behaviour

EZHV SOI process used for the High Voltage die

Reference Driver



TEA2017AAT/3

Faster start-up behaviour to comply with the new Intel ATX 3 specification (§4.3 in Intel ATX Version 3.0 spec → T1: Power-on time)

New improved ABCD3HV+ SOI process used for the High Voltage die

Driver: improved driver performance

